

The 8th International Congress on Laser Advanced Materials Processing May 21 - 24, 2019

International Conference Center Hiroshima, Hiroshima, Japan http://www.jlps.gr.jp/lamp/lamp2019/

Sponsorship and Advertisement Opportunities

Welcome to join us at LAMP2019!

The International Congress on Laser Advanced Materials Processing (LAMP) deals with science and technology of advanced laser materials processing covering precision microfabrication and high power laser processing. LAMP2019 is held during MAY 21-24, 2019 in Hiroshima, Japan. LAMP2019 consists of International Symposia on Laser Precision Microfabrication (LPM) and High Power Laser Processing (HPL) and covers hardware as well as software for fundamental research and industrial applications in both micro and macro processing. LAMP2019 is planned as a four-day event with a Plenary Session, LPM 20th Year Anniversary Session, Oral and Poster Sessions, Special Sessions dealing with topical issues, and the exhibition with inviting most important world authorities in this field. The aim of this congress is to provide a forum for discussion of fundamental aspects of laser-matter interaction, the stateof-the-art of laser materials processing, and topics for the next generation with fundamental scientists, end users and laser manufactures. We expect that LAMP2019 would play an important role not only for understanding fundamental knowledge of laser materials processing but also forecasting future technologies to be developed and the future laser market.

We would like to encourage you to become LAMP2019 sponsors. We hope that the Sponsorship will strongly assist you to extend your world-wide business opportunities. For the details, please refer to the following pages. Thank you for your attention in advance.

Dr. Koji Sugioka, General Chair, LAMP2019

General Chair: Koji Sugioka, RIKEN, Japan Co-Chairs: Hiroyuki Niino, AIST, Japan

Yongfeng Lu, University of Nebraska-Lincoln, USA

Michael Schmidt, Friedrich-Alexander-Universität Erlangen-Nürnberg, Germany

Steering Committee Chair: Kenji Shinozaki, Hiroshima University, Japan

Organized by: JLPS- Japan Laser Processing Society

Partnership Categories

GOLD LEVEL sponsors: Poster Session Sponsor (Open for 1 contribution) SOLD-OUT

Plenary Session Sponsor (Open for 1 contribution) SOLD-OUT

Banquet Sponsor (Open for 1 contribution)

Conference Bag Sponsor (For 1 contribution) SOLD-OUT

Joint Session Sponsor (Open for 1 contribution) SOLD-OUT

SILVER LEVEL sponsors: Award Sponsor (Open for 1 contribution) SOLD-OUT

Coffee Break Sponsor (For 1 contribution) DAY-1 & DAY-2 SOLD-OUT

Coffee Break Sponsor (Open for 1 contribution) DAY-3 & DAY-4

BRONZE LEVEL sponsors: Open for 20 contributions

Advertisements sponsors: Open for 20 contributions for program booklets

GOLD LEVEL SPONSORSHIP						
Items	Plenary Session Sponsor (1) Banquet Sponsor (1), Conference Bag- Sponsor (1), Joint Session Sponsor (1), Poster Session Sponsor (1)					
Contents	 Company Advertisements (A4 sized; one page) will be listed in the program booklets. Company name will be displayed at each applicable room/site of the venue. Company name will be featured on the LAMP2019 website. 					
Price	JPY 200,000- per order					
Special Arrangements	 One registration fee will be waived per one order. Note: Banquet and Online Proceedings are not included in this waiver. If you wish to attend banquet, please order it additionally. Contact: lamp-reg@jlps.gr.jp Per 2 orders, the sponsorship name will be raised up to DIAMOND LEVEL. 2 registration fees will be waived. (Not included the banquet and proceedings) Company name will be listed on the LAMP2019 website and program booklets List of Attendees' Affiliations and/or Companies will be sent to you after the congress. The list does NOT include the information of the attendees' personal information. If you wish, you can become an exhibitor in Table-Top Exhibitions with special discount. Contact: lamp2019@jlps.gr.jp 					
Submission of Ad Materials	Please create your advertisement(s) complying with the guidelines mentioned below, and submit PDF file(s) to us by e-mail no later than the due date.					
How to Apply	Please fill out the final page of this file, and fax or send it back to us.					

< Guidelines for Advertisements Specifications>

Size: One A4 sized paper (Height 297mm x Width 210mm)
Margins: Top/Bottom: Over 20mm, Right/Left : Over 15mm

Color: Both color and black & white versions

Language: English is preferable.

File: Fully completed clear <u>PDF file</u>, please.

Do not divide texts and figures separately.

Submission: Please send the electric file by e-mail at lamp2019@jlps.gr.jp

<Ad Submission Due Date> April 10, 2019, JST

SILVER LEVEL SPONSORSHIP					
Items	Award Sponsor for "Outstanding Paper Awards" Coffee Break Sponsor for DAY-1 & DAY-2 Coffee Break Sponsor for DAY-3 & DAY-4				
Contents	 Company Advertisements 1/2 page of A4; Equivalent to A5 sized paper; Ad orientation with longer horizontal size than vertical) will be listed in the program booklet to be distributed on site. Company Name will be displayed at each applicable room or site of the congress venue. Company Name will be featured in LAMP2019 website. 				
Price	JPY 150,000- per order				
Special Arrangements	 One registration fee will be waived per one order. Note: Banquet and Online Proceedings are not included in this waiver. If you wish to attend banquet, please order it additionally. Contact: lamp-reg@jlps.gr.jp Per 2 orders, the sponsorship name will be raised up to PLATINUM LEVEL. 2 registration fees will be waived. (Not included the banquet and proceedings) Company name will be listed on the LAMP2019 website and program booklets. List of Attendees' Affiliations and/or Companies will be sent to you after the congress. The list does NOT include the information of the attendees' personal information. 				
Submission of Ad Materials	Please create your advertisement(s) complying with the guidelines mentioned below, and submit your electric file(s) to us by e-mail no later than the due date.				
How to Apply	Please fill out the final page of this file, and fax or e-mail back to us.				

<Guidelines for Advertisements Specifications>

Size: Half size of A4 sized paper (Height 148mm x Width 210mm)

[Equivalent to A5 sized paper; Ad orientation with longer horizontal size than vertical] For 2 orders from one company, you can make one A4 sized ad instead of 2 ads at the half size (A5 size) of A4 sized paper.

Margins: Top/Bottom/Right/Left: Over 15mm

Margins for A4 sized ad: Top/Bottom: Over 20mm, Right/Left: over 15mm

Color: Both color and black & white versions

Language: English is preferable.

File: Fully completed clear PDF file, please. Please do not divide texts and figures separately.

Submission: Please send the electric file by e-mail.

LAMP2019 Secretariat, Japan Laser Processing Society c/o Joining and Welding Research Institute, Osaka University

11-1 Mihogaoka, Ibaraki, Osaka 567-0047, Japan

TEL/FAX: +81-6-6879-8642, E-mail: lamp2019@jlps.gr.jp

<Ad Submission Due Date> April 10, 2019, JST

BRONZE LEVEL SPONSORSHIP (without advertisement)					
Items	20 contributions				
Contents	Company Name will be shown on the program booklets. Company Name will be featured in LAMP2019 website.				
Price	JPY 40,000- per order				
Special Arrangements	 Per 4 orders from one company, one registration fee will be waived. Note: Banquet and Online Proceedings are not included in this waiver. If you wish to attend banquet, please order it additionally. Contact: lamp-reg@ilps.gr.jp Company name will be listed on the LAMP2019 website and program booklets. List of Attendees' Affiliations and/or Companies will be sent to you after the congress. The list does NOT include the information of the attendees' personal information. 				
How to Apply	Please fill out the final page of this file, and fax or e-mail back to us.				
Please e-mail the application form to: lamp2019@jlps.gr.jp					

ADVERTISEMENT sponsor						
Items	Open for 20 advertisements					
Contents	1. Company Advertisement(s) (1/2 of A4; Equivalent to A5 sized paper; Ad orientation with longer horizontal size than vertical) will be listed in the program booklets. 2. Company and Name will be featured on LAMP2019 website.					
Price	JPY 70,000- per order; half size of A4 sized paper [Equivalent to A5 sized paper; Ad orientation with longer horizontal size than vertical]					
Special Arrangements	 Per 2 orders from one company: One registration fee will be waived. Note: Banquet and Online Proceedings are not included in this waiver. If you wish to attend banquet, please order it additionally. Contact: lamp-reg@jlps.gr.jp List of Attendees' Affiliations and/or Companies will be sent to you after the congress. The list does NOT include the information of the attendees' personal information. 					
Submission of Ad Materials	Please create your advertisement(s) complying with the guidelines mentioned below, and submit PDF file(s) to us by e-mail no later than the due date.					
How to Apply	Please fill out the final page of this file, and fax or e-mail back to us.					

< Guidelines for Advertisements Specifications >

Size: Half size of A4 sized paper (Height 148mm x Width 210mm)

[Equivalent to A5 sized paper; Ad orientation with longer horizontal size than vertical]

Per 2 orders from one company, you can make one A4 sized ad instead of

2 ads at the half size of A4 sized paper.

Margins for regular order :Top/Bottom/Right/Left : Over 15mm

Margins for A4 sized ad: Top/Bottom: Over 20mm, Right/Left: over 15mm

Color: Both color and black & white versions

Language: English is preferable.

File: Fully completed clear PDF file, please. Do not divide texts and figures separately.

Submission: Please send the electric file by e-mail.

LPM2017 Secretariat, Japan Laser Processing Society

c/o Joining and Welding Research Institute, Osaka University

11-1 Mihogaoka, Ibaraki, Osaka 567-0047, Japan

TEL/FAX: +81-6-6879-8642, E-mail: lpm2017@jlps.gr.jp

<Ad Submission Due Date> April 10, 2019, JST

PAYMENT METHOD FOR SPONSORSHIPS AND ADVERTISEMENTS

Payment Due Date: April 10, 2019, JST

[Bank Account Information for Wire-Transfer to LPM2017 (JLPS)]

Bank name: Sumitomo Mitsui Banking Corporation

Branch: Minami Senri Branch

SWIFT Code: SMBCJPJT Bank code: #0009 Branch code: #189

Account name: "Ittpan Shadan Hojin Laser Kako Gattkai"

Account type: Regular (Futsu)

Account Number: 1159822

Bank address: 1-2-D9-101, Tsukumodai, Suita-city, Osaka 565-0862, Japan

Bank phone #: +81-6-6833-1911

(Note) When you make the wire transaction, please make sure to add ¥4000

bank handling charge additionally.

How to apply:

Please fill out the order form shown on the next page, and fax or e-mail back to us.

Exhibitions and Catalog Display

Please contact LAMP2019 Secretariat for the order form.

E-mail: lamp2019@jlps.gr.jp

LAMP2019 PARTNERSHIP ORDER FORM								
Date:	(Month/Date/Yea	mber e use)						
Company Name	(This is for Listing Do not omit anyt	ny name correctly.						
Branch Name								
Department (Your title)								
Person in Charge	(First name, Middle Name(if applicable), LAST NAME)							
	Street Address							
	City							
Your Address	Prefecture/ State							
	TEL	TEL: +Country Code - Area Code - TEL Number						
	E-mail	(Clearly write under-bar, hyphen, etc.)						
		Items	Fee (JPY=Japanese Yer	Quantity	Sub-Total Amount			
	GOLD LEVEL Sponsorship Poster Session Sponsor SOLD-OUT Plenary Session Sponsor SOLD-OUT Banquet Sponsor Bag Sponsor SOLD-OUT Joint Session Sponsor SOLD-OUT		JPY 200,000)-	JPY			
	SILVER LEV Award Sponsor Coffee Break fo	/EL Sponsorship	JPY 150,000)-	JPY			
Partnership	BRONZE LE	VEL Sponsorship	JPY 40,000)-	JPY			
	Advertisem	nent	JPY 70,000)-	JPY			
		JPY						
		JPY 4,000-						
	Credit card ha ☐ VISA ☐	Sub-Total Amount x 0.05=						
	Card Number: Card Holder's Name (Print clearly.) Exp. Date (Month/Year):				JPY			
		JPY						
Link to your Company	1 1000 0 1 100 1 1 1 1 1 1 1 1 1 1 1 1							
Website	Your URL	http://						
Advertisement(s) will be posted on (Month/Date/Year)								

- The above-inputted information will not be used for any other purpose except the correspondence with LAMP2019 secretariat.
- The application will be accepted in order of receipt. Please acknowledge the possibility of sold-out(s) before the application due date.
- If you pay by credit card, do not e-mail this form. Please make sure to send it by FAX for security reasons. (or please send the PDF file which is locked by password, then, please let us know the password to open the file.)